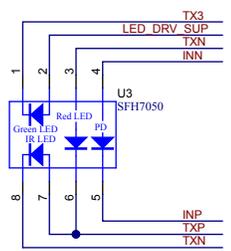
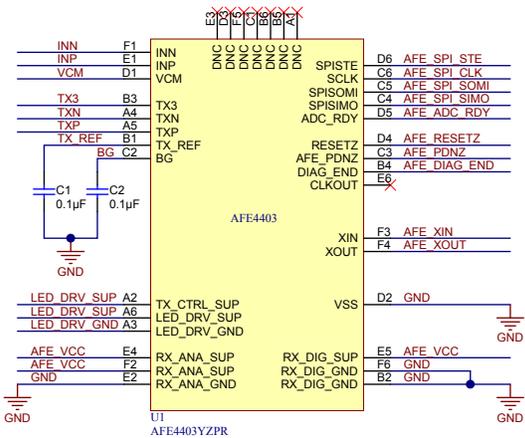


OSRAM Sensor

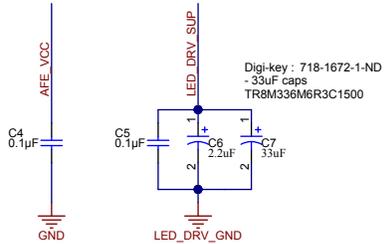
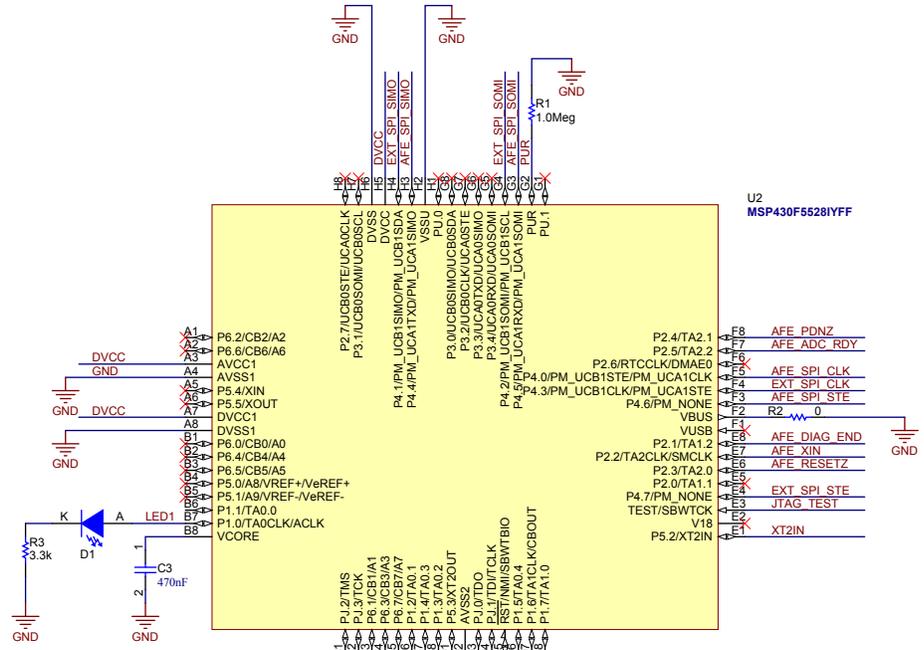


place decoupling caps close by LED_DRV_SUP and use multiple VIAs

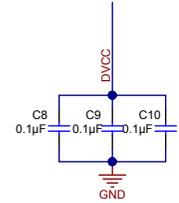
AFE4403



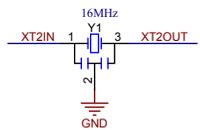
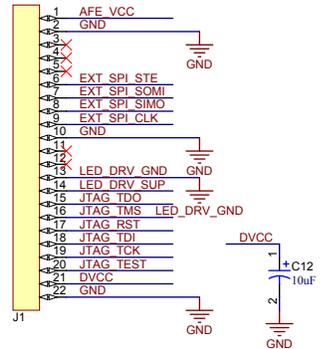
MSP430F5528



Decoupling Caps Close to AFE



Decoupling Caps Close to MSP430



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